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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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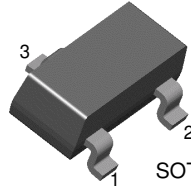
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



BCX20

NPN Epitaxial Silicon Transistor

Switching and Amplifier Applications



SOT-23
Marking: U2
1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

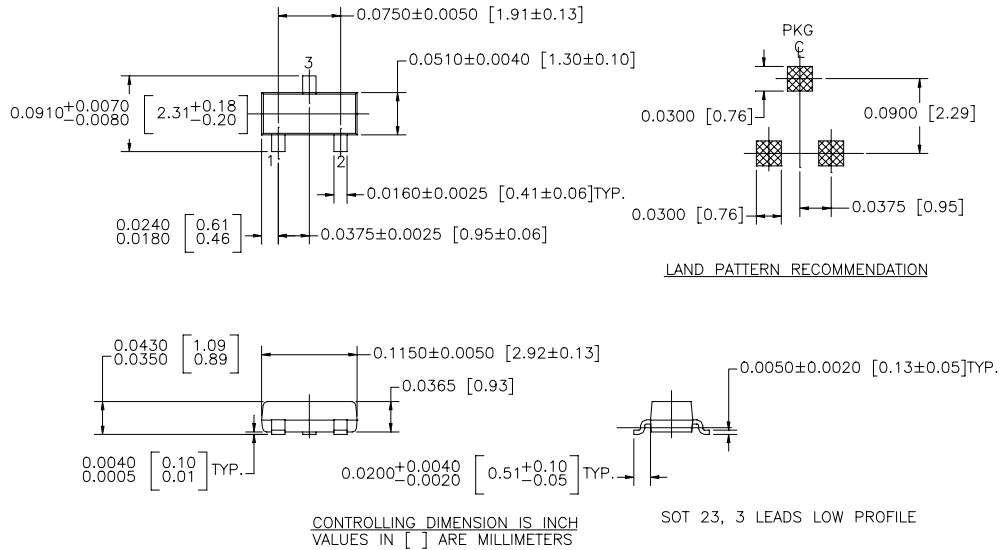
Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	30	V
V_{CEO}	Collector-Emitter Voltage	25	V
V_{EBO}	Emitter-Base Voltage	5	V
I_C	Collector Current (DC)	800	A
P_C	Collector Dissipation	310	W
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-65 ~ 150	$^\circ\text{C}$

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10\text{mA}$, $I_B = 0$	25		V
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C = 100\mu\text{A}$, $V_{BE} = 0$	30		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu\text{A}$, $I_C = 0$	5		V
I_{CBO}	Collector Cut-off Current	$V_{CE} = 20\text{V}$, $V_{BE} = 0$		100	nA
I_{EBO}	Emitter-Base Cut-off Current	$V_{BE} = 5\text{V}$, $I_C = 0$		10	nA
h_{FE1}	DC Current Gain	$V_{CE} = 1\text{V}$, $I_C = 100\text{mA}$	100	600	
h_{FE2}		$V_{CE} = 1\text{V}$, $I_C = 300\text{mA}$	70		
h_{FE3}		$V_{CE} = 1\text{V}$, $I_C = 500\text{mA}$	40		
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 500\text{mA}$, $I_B = 50\text{mA}$		0.62	V
$V_{BE(on)}$	Base-Emitter Saturation Voltage	$V_{CE} = 1\text{A}$, $I_B = 500\text{mA}$		1.2	V

Mechanical Dimensions

SOT-23



- NOTE : UNLESS OTHERWISE SPECIFIED
- STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS
MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
 - REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

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E ² CMOS™	ꝑC™	MSX™	QT Optoelectronics™	TinyLogic®
EnSigna™	i-Lo™	MSXPro™	Quiet Series™	TINYOPTO™
FACT™	ImpliedDisconnect™	OCX™	RapidConfigure™	TruTranslation™
FACT Quiet Series™		OCXPro™	RapidConnect™	UHC™
Across the board. Around the world.™		OPTOLOGIC®	∞SerDes™	UltraFET®
The Power Franchise®		OPTOPLANAR™	SILENT SWITCHER®	UniFET™
Programmable Active Droop™		PACMAN™	SMART START™	VCX™

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Datasheet Identification	Product Status	Definition
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